

3A, 20V - 200V Schottky Barrier Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- Guard ring for overvoltage protection
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.210g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	3	A
V_{RRM}	20 - 200	V
I_{FSM}	75, 100	A
$T_{J\ MAX}$	125, 150	°C
Package	DO-214AB (SMC)	
Configuration	Single die	



DO-214AB (SMC)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)											
PARAMETER	SYMBOL	SS 32H	SS 33H	SS 34H	SS 35H	SS 36H	SS 39H	SS 310H	SS 315H	SS 320H	UNIT
Repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	90	100	150	200	V
Reverse voltage, total rms value	$V_{R(RMS)}$	14	21	28	35	42	63	70	105	140	V
Forward current	I_F	3									A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	100				75					A
Critical rate of rise of off-state voltage	dV/dt	10,000									V/ μs
Junction temperature	T_J	- 55 to +125				- 55 to +150					°C
Storage temperature	T_{STG}	- 55 to +150									°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	13	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	52	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	14	°C/W

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	SS32H SS33H SS34H	$I_F = 3A, T_J = 25^\circ\text{C}$	V_F	-	0.50	V
	SS35H SS36H			-	0.75	V
	SS39H SS310H			-	0.85	V
	SS315H SS320H			-	0.95	V
	SS32H SS33H SS34H	$I_F = 3A, T_J = 100^\circ\text{C}$		-	0.40	V
	SS35H SS36H			-	0.65	V
	SS39H SS310H			-	0.70	V
	SS315H SS320H			-	0.80	V

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Reverse current @ rated $V_R^{(2)}$	SS32H SS33H SS34H SS35H SS36H	$T_J = 25^\circ\text{C}$	I_R	-	0.5	mA
	SS39H SS310H SS315H SS320H			-	0.1	mA
	SS32H SS33H SS34H	$T_J = 100^\circ\text{C}$		-	10	mA
	SS35H SS36H			-	5	mA
	SS39H SS310H SS315H SS320H			-	-	mA
	SS32H SS33H SS34H			-	-	mA
	SS35H SS36H	$T_J = 125^\circ\text{C}$		-	-	mA
	SS39H SS310H SS315H SS320H			-	0.5	mA

Notes:

1. Pulse test with $PW = 0.3\text{ms}$
2. Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	DEVICE MARKING
SS32H	DO-214AB (SMC)	3,000 / Tape & Reel	SS32
SS33H	DO-214AB (SMC)	3,000 / Tape & Reel	SS33
SS34H	DO-214AB (SMC)	3,000 / Tape & Reel	SS34
SS35H	DO-214AB (SMC)	3,000 / Tape & Reel	SS35
SS36H	DO-214AB (SMC)	3,000 / Tape & Reel	SS36
SS39H	DO-214AB (SMC)	3,000 / Tape & Reel	SS39
SS310H	DO-214AB (SMC)	3,000 / Tape & Reel	SS310
SS315H	DO-214AB (SMC)	3,000 / Tape & Reel	SS315
SS320H	DO-214AB (SMC)	3,000 / Tape & Reel	SS320

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

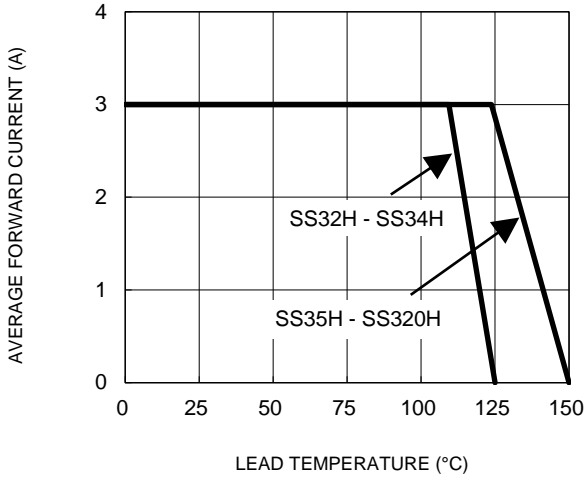


Fig.2 Typical Junction Capacitance

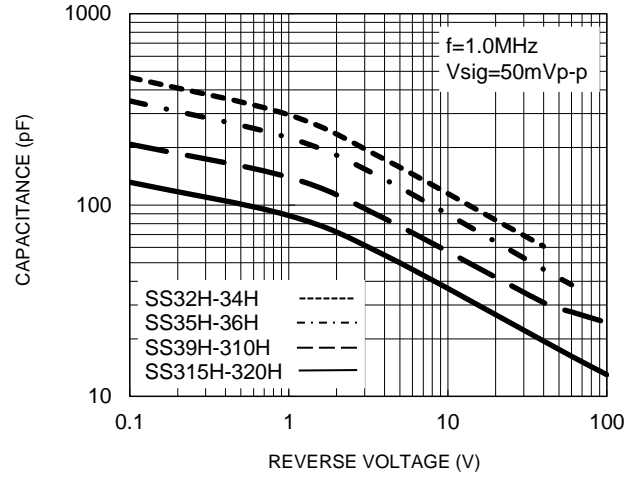


Fig.3 Typical Reverse Characteristics

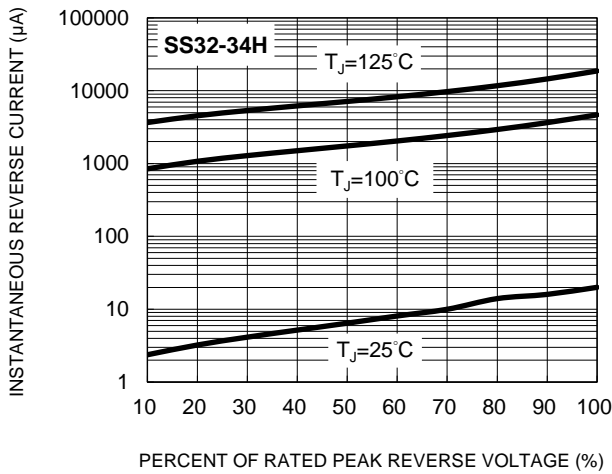


Fig.4 Typical Forward Characteristics

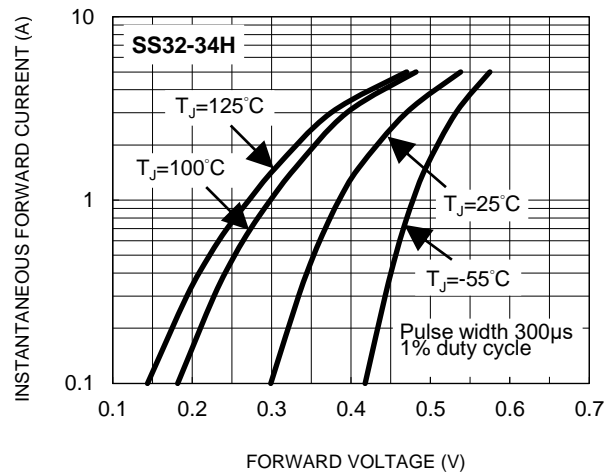


Fig.5 Typical Reverse Characteristics

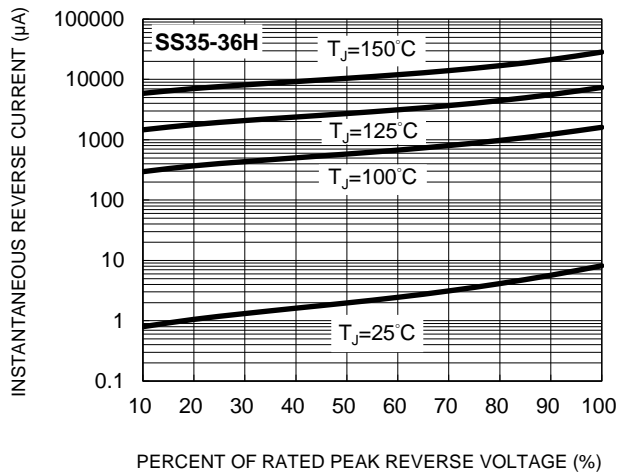
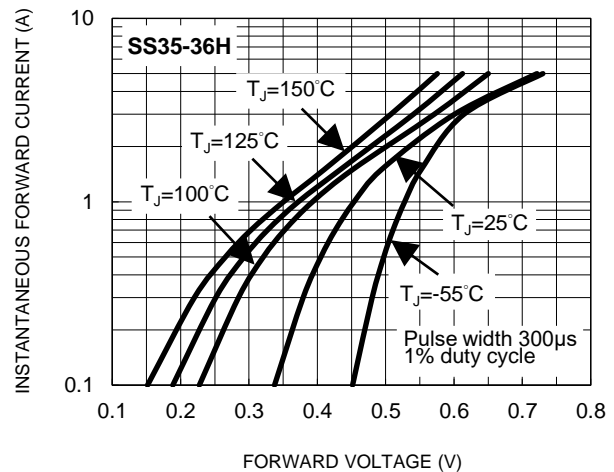


Fig.6 Typical Forward Characteristics



CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.7 Typical Reverse Characteristics

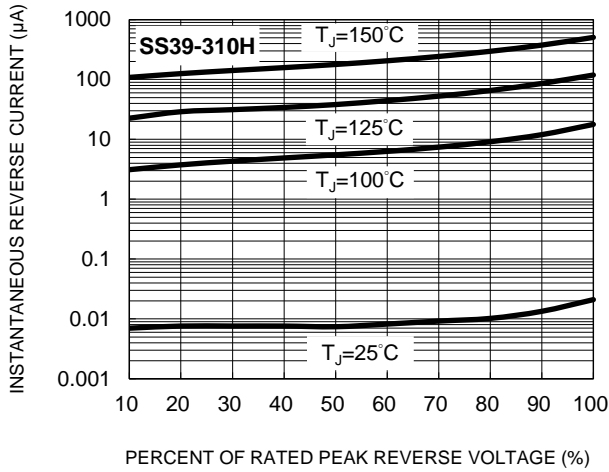


Fig.8 Typical Forward Characteristics

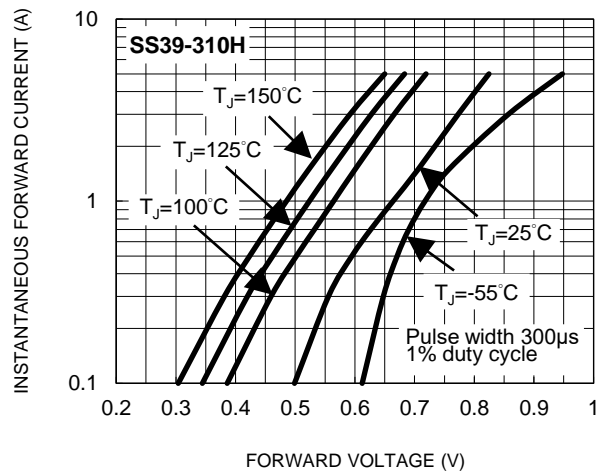


Fig.9 Typical Reverse Characteristics

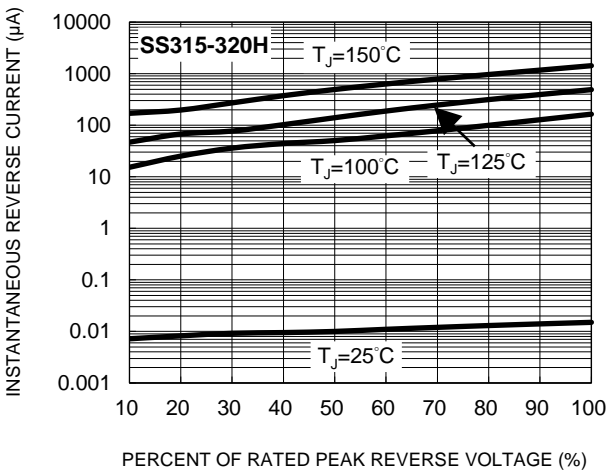


Fig.10 Typical Forward Characteristics

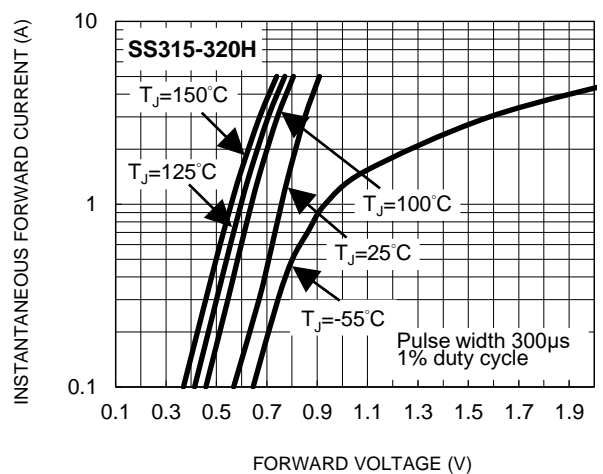


Fig.11 Typical Forward Power Dissipation vs. Forward Current

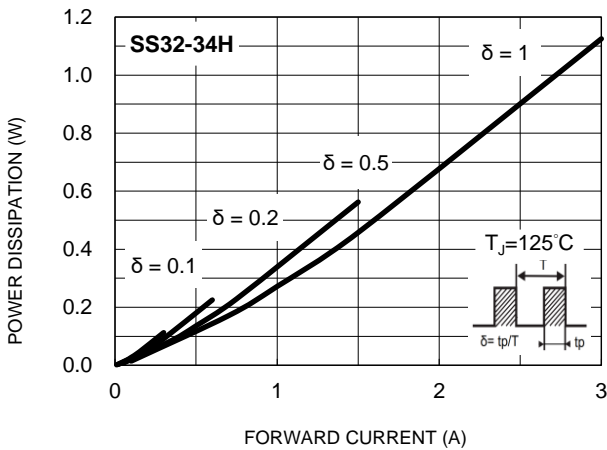
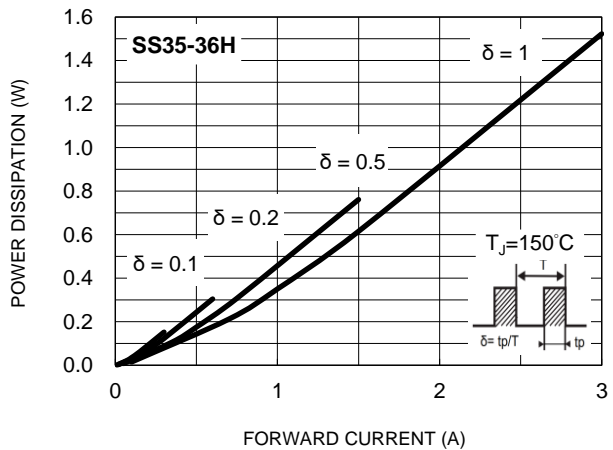


Fig.12 Typical Forward Power Dissipation vs. Forward Current



CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.13 Typical Forward Power Dissipation vs. Forward Current

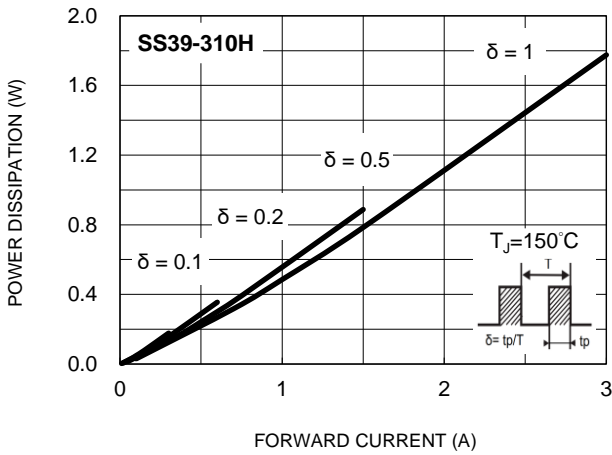


Fig.14 Typical Forward Power Dissipation vs. Forward Current

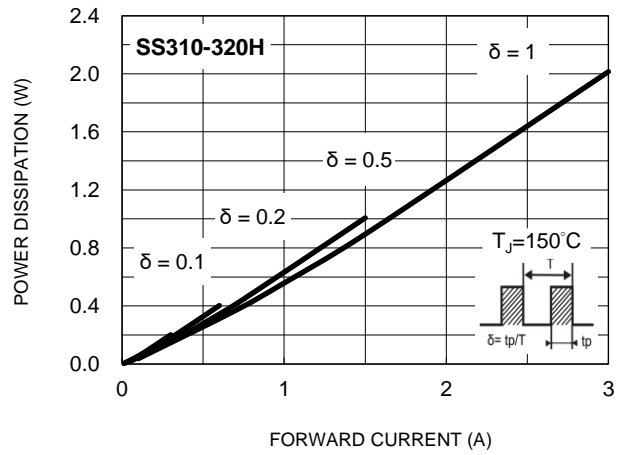


Fig.15 Maximum Non-Repetitive Forward Surge Current

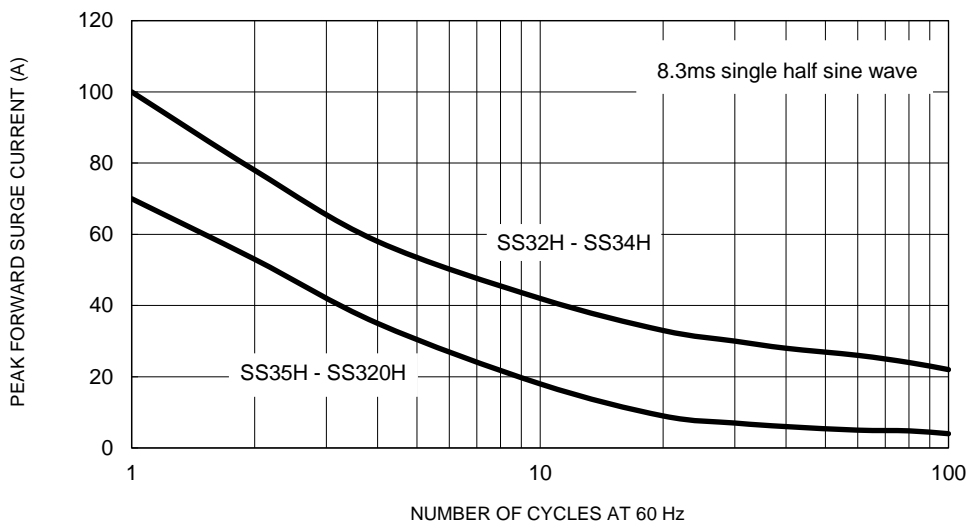
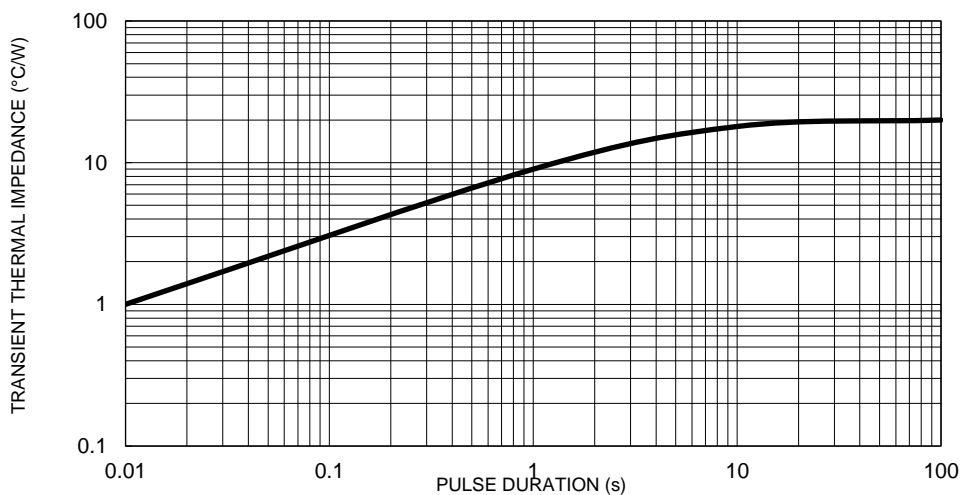
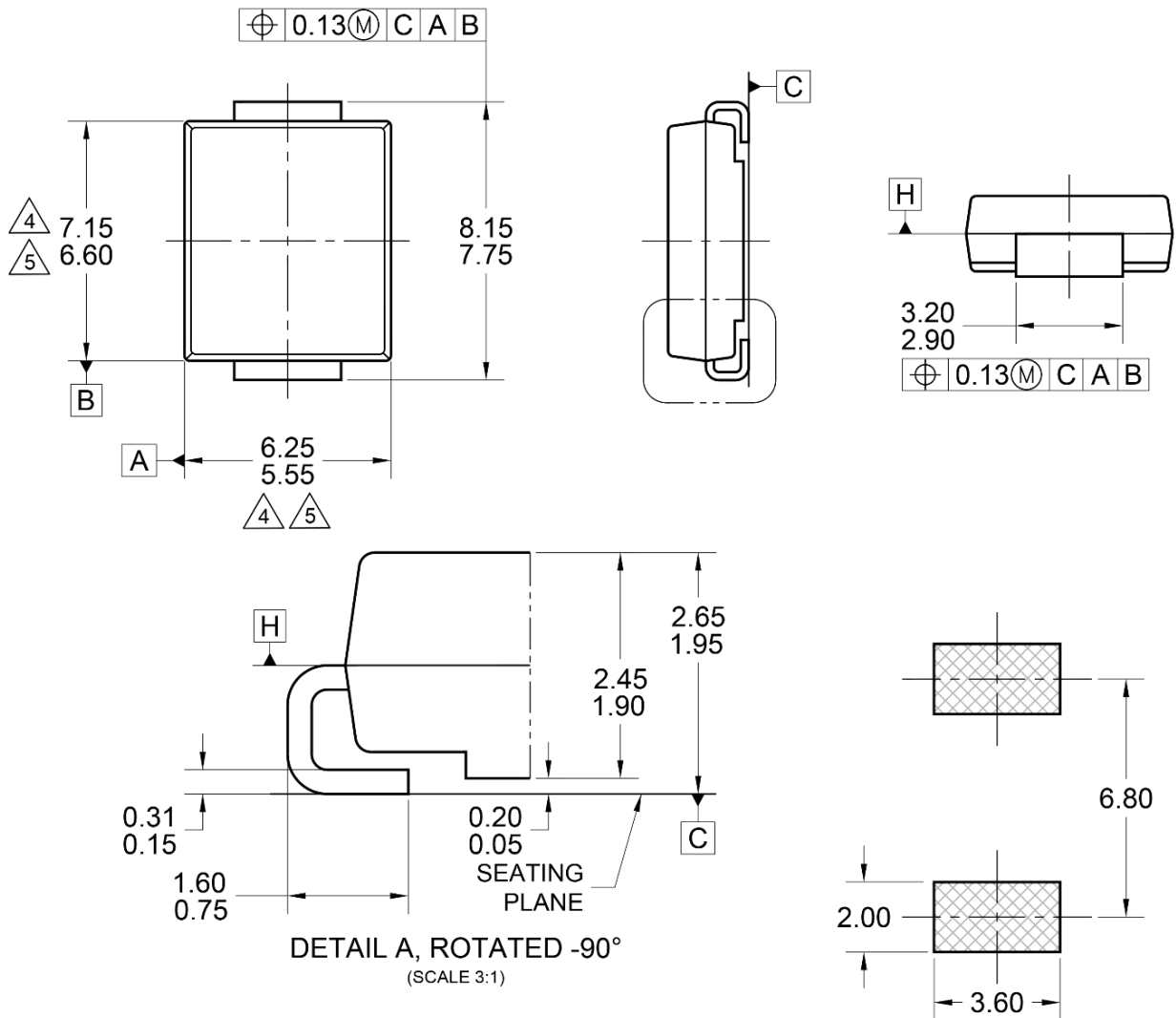


Fig.16 Typical Transient Thermal Characteristics



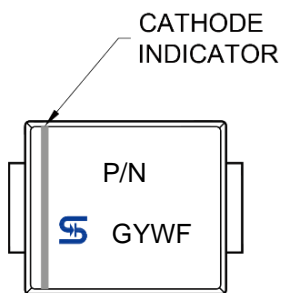
PACKAGE OUTLINE DIMENSIONS

DO-214AB (SMC)



DETAIL A, ROTATED -90°
(SCALE 3:1)

SUGGESTED PAD LAYOUT



MARKING DIAGRAM

P/N = Device marking
G = Green compound
YW = Date code
F = Factory code

NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AB, ISSUE D.
4. MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
5. MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
6. DWG NO. REF: HQ2SD07-DO214SMC-036 REV A.

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